



Dimensions

Footprint	7343
L	7.3mm +/-0.3mm
W	4.3mm +/-0.3mm
H	2mm MAX
S	1.3mm +/-0.3mm
F	2.4mm +/-0.1mm
K	1.7mm TYP

Packaging Specifications

Packaging	T&R, 330mm
Packaging Quantity	3750

General Information

Series	B450
Dielectric	MnO2 Tantalum
Style	SMD Chip
Description	SMD, Molded, Low Profile, Low ESR, Surge Robust
Features	Low Profile, Low ESR, Surge Robust
RoHS	Yes
Termination	Tin
AEC-Q200	No
Notes	Obsolete. Old Part Number [Obsolete] Was B45035V1066M607.

Specifications

Capacitance	10 uF
Capacitance Tolerance	20%
Voltage DC	35 VDC (85C), 23.45 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	85°C
Dissipation Factor	6%
Failure Rate	N/A
Resistance	0.6 Ohms (100kHz)
Ripple Current	460 mAmps (25C), 414 mAmps (85C), 184 mAmps (125C)
Leakage Current	3.5 uA